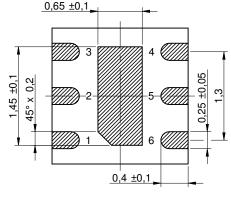
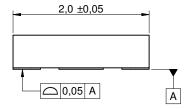
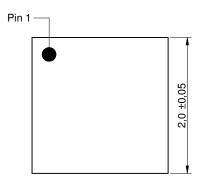
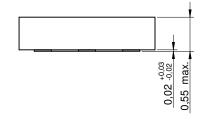
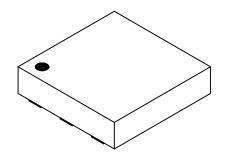
# **Dimensions: [mm]**





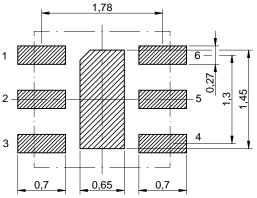






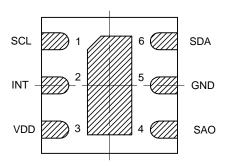
Scale - 18:1

# Recommended Land Pattern: [mm] (Top View)

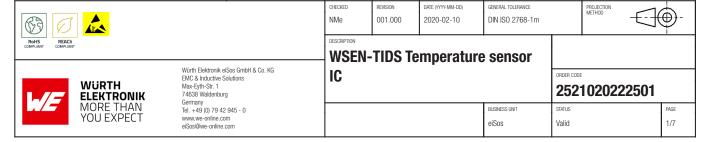


Scale - 18:1

## **Product Specific Pinning: (Top View)**



Scale - 18:1



## **Temperature Sensor Specification:**

Properties		Test conditions		Value				
rioperues		iest conditions	min.	typ.	max.	Unit		
Measurement range	T <sub>RANGE</sub>		-40		125	°C		
Absolute Accuracy T <sub>ACC_ABS</sub>		T = -10 to 60 °C	-0.5 °C	±0.25 °C	0.5 °C			
Total accuracy T <sub>ACC_TC</sub>		T = -40 to 125 °C	-1 °C	±0.7 °C	1 °C			
Resolution	RES <sub>T</sub>			16		bits		
Sensitivity	SEN <sub>T</sub>			0.01 °C/digit				
Output data rate ODR		Continuous mode	25		200	Hz		
Noise (RMS) T <sub>NOISE</sub>		ODR = 25 Hz		0.025		°C RMS		

# **Electrical Properties:**

Dranautica		Test conditions		Value		Unit
Properties		Test conditions	min.	typ.	max.	Ullit
Operating supply voltage	$V_{DD}$		1.5	3.3	3.6	V
Current consumption in single conversion mode	I <sub>DD_SC</sub>			1.75		μА
Current consumption in power down mode	I <sub>DD_PD</sub>			0.6		μА
Peak current consumption	I <sub>DD_PEAK</sub>	During conversion		120	180	μА
Digital input voltage - high-level	V <sub>IH</sub>		0.7 * V <sub>DD</sub>			
Digital input voltage - low-level	$V_{\rm IL}$				0.3 * V <sub>DD</sub>	
Digital output voltage - high- level	V <sub>OH</sub>		V <sub>DD</sub> - 0.2 V			

# **Absolute Maximum Ratings:**

Properties		Va	lue	Unit
Fruperties		min.	max.	Oilit
Input voltage VDD pin	$V_{DD}$	-0.3	4.8	V

# **Absolute Maximum Ratings:**

Properties		Va	lue	Unit
rioperues		min.	max.	Ullit
Input voltage SDA, SCL,CS & SAO pins 1)	V <sub>IN</sub>	-0.3	V <sub>DD</sub> + 0.3	V

<sup>1)</sup> SCL,SDA and SAO are control pins. Supply voltage on any pin should never exceed 4.8 V

#### **General Information:**

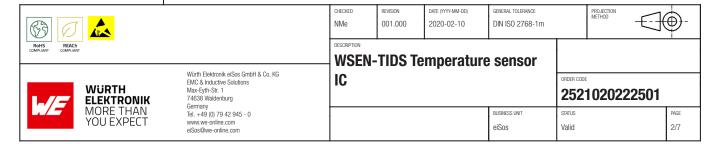
Operating Temperature	-40 up to +125 °C
Storage Conditions (in original packaging)	< 40 °C; < 75 % RH
Communication interface	1 <sup>2</sup> C
Moisture Sensitivity Level (MSL)	1
Electrostatic discharge protection (HBM)	2 kV

## **Product Specific Pinning:**

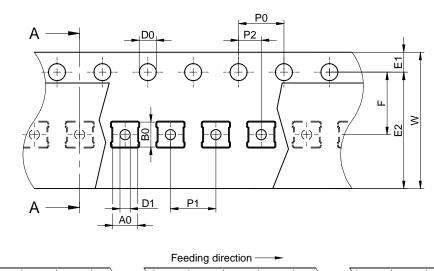
Pin	Pad	Description	1/0
SCL	1	I <sup>2</sup> C serial clock	Input
INT	2	Interrupt	Output
VDD	3	Positive supply voltage	Supply
SAO	4	I <sup>2</sup> C device address selection	Input
GND	5	Negative supply voltage	Supply
SDA	6	I <sup>2</sup> C serial data	Input/Output

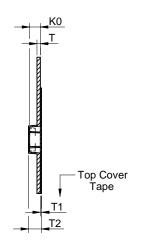
#### **Certification:**

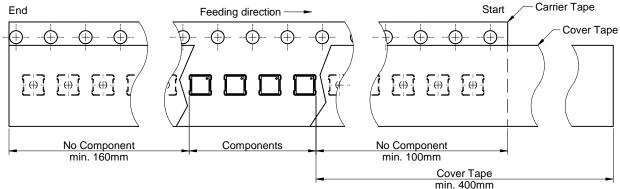
RoHS Approval	Compliant [2011/65/EU&2015/863]
REACh Approval	Conform or declared [(EC)1907/2006]



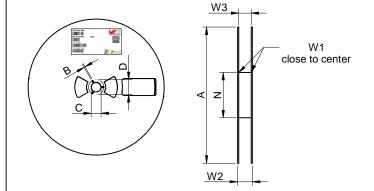
# Packaging Specification - Tape and Reel: [mm]

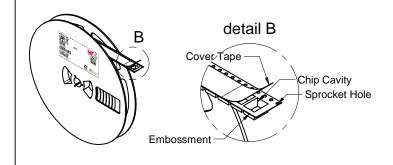




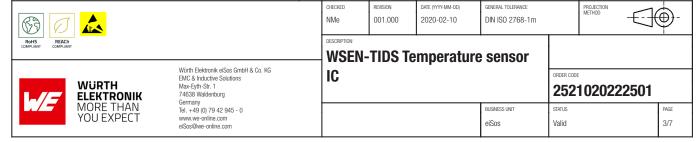


Таре Туре	A0 (mm)	B0 (mm)	W (mm)	T (mm)	T1 (mm)	T2 (mm)	KO (mm)	P0 (mm)	P1 (mm)	P2 (mm)	D0 (mm)	D1 (mm)	E1 (mm)	E2 (mm)	F (mm)	Material	Qty. (pcs.)
	±0,05	±0,05	+0,3/ -0,1	±0,05	ref.	typ.	typ.	±0,1	±0,1	±0,05	+0,1/-0,0	min.	±0,1	min.	±0,05		
2a	2.30	2.30	12.00	0.25	0.10	1.20	1.00	4.00	4.00	2.00	1.50	1.50	1.75	10.25	5.50	Polystyrene	3000

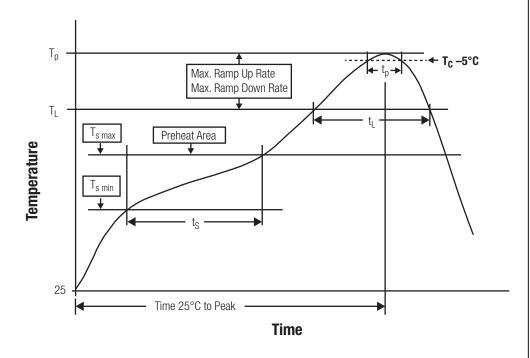




A (mm)	B (mm)	C (mm)	D (mm)	N (mm)	W1 (mm)	W2 (mm)	W3 (mm)	W3 (mm)	Material
± 2,0	min.	min.	min.	typ.	+ 2,0	max.	min.	max.	
178,00	1,50	12,80	20,20	60,00	12,40	18,40	11,90	15,40	Polystyrene



# **Classification Reflow Profile for SMT components:**



# **Classification Reflow Soldering Profile:**

Profile Feature		Value
Preheat Temperature Min	T <sub>s min</sub>	150 °C
Preheat Temperature Max	T <sub>s max</sub>	200 °C
Preheat Time $t_s$ from $T_{s  min}$ to $T_{s  max}$	t <sub>s</sub>	60 - 120 seconds
Ramp-up Rate (T <sub>L</sub> to T <sub>P</sub> )		3 °C/ second max.
Liquidous Temperature	T <sub>L</sub>	217 °C
Time t <sub>L</sub> maintained above T <sub>L</sub>	t <sub>L</sub>	60 - 150 seconds
Peak package body temperature	T <sub>p</sub>	$T_p \le T_c$ , see Table below
Time within 5°C of actual peak temperature	t p	20 - 30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> ) <sup>1)</sup>		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

<sup>1)</sup> In order to reduce residual stress on the sensor components, the recommended ramp-down temperature slope should not exceed 3°C/sec. refer to IPC/ JEDEC J-STD-020E

# Package Classification Reflow Temperature (T<sub>c</sub>):

Properties	Volume mm³ <350	Volume mm <sup>3</sup> 350-2000	Volume mm³ >2000	
PB-Free Assembly I Package Thickness < 1.6 mm	260 °C	260 °C	260 °C	
PB-Free Assembly   Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C	
PB-Free Assembly I Package Thickness > 2.5 mm	250 °C	245 °C	245 °C	

refer to IPC/ JEDEC J-STD-020E

		NMe	001.000	DATE (YYYY-MM-DD) 2020-02-10	GENERAL TOLERANCE DIN ISO 2768-1m		PROJECTION METHOD ————	<b>-</b>
ÜRTH EKTRONIK	Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Pyth-Str. 1 74638 Waldenburg Germany	DESCRIPTION WSEN-IC	TIDS Te	emperature	e sensor	ORDER CODE <b>252</b> 1	1020222501	
ORE THAN OU EXPECT	Germany Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com				BUSINESS UNIT eiSos	status Valid		PAGE 4/7

#### **Further information**

### **Component Libraries:**



3D\_2521020222501



Altium\_WSEN (V4.1)



Eagle\_WSEN (V4.1)



Download\_IGS\_2521020222501



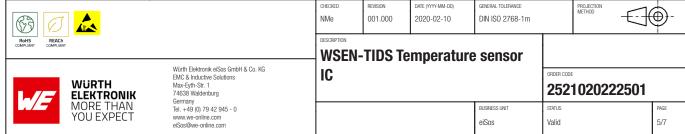
Download\_STP\_2521020222501

#### **Get a Quote:**

Request a quote here!

#### **Tutorials:**

- MEMS Sensor Portfolio & Customer Service (PDF)
- Technical Support
- Manuals
- Software Downloads
- Wireless Connectivity & Sensors Overview



# **Cautions and Warnings:**

# The following conditions apply to all goods within the product series of sensor components of Würth Elektronik eiSos GmbH & Co. KG:

#### General:

- This electronic component is designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for written approval (following the PPAP procedure) before incorporating the components into any
  equipment in fields such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control,
  ship control), transportation signal, disaster prevention, medical, public information network, etc. where higher safety and reliability are
  especially required and/or if there is the possibility of direct damage or human injury.
- Electronic components that will be used in safety-critical or high-reliability applications, shall be pre-evaluated by the customer.
- The component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions
  specified in the datasheet are not met, the wire insulation may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged
- Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth
  Elektronik does not warrant any customer qualified product characteristics beyond Würth Elektroniks' specifications, for its validity and
  sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the
  authority of the customer. All technical specifications for standard products also apply to customer specific products.

#### **Product specific:**

#### Soldering:

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- · All other soldering methods are at the customers' own risk.

#### **Cleaning and Washing:**

- Washing agents used during the production to clean the customer application might damage or change the characteristics of the component. Washing agents may have a negative effect on the long-term functionality of the product.
- Using a brush during the cleaning process may damage the component. Therefore, we do not recommend using a brush during the PCB cleaning process.

#### **Potting and Coating:**

Potting material might shrink or expand during and after hardening. This might apply mechanical stress on the components, which can
influence the characteristics of the transfer function. In addition, potting material can close existing openings in the housing. This can
lead to a malfunction of the component. Thus, potting is not recommended.

Conformal coating may affect the product performance. We do not recommend coating the components.

#### **Storage Conditions:**

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer
  degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of
  shipment.
- Do not expose the components to direct sunlight.
- The storage conditions in the original packaging are defined according to DIN EN 61760-2.
- For a moisture sensitive component, the storage condition in the original packaging is defined according to IPC/JEDEC-J-STD-033. It is
  also recommended to return the component to the original moisture proof bag and reseal the moisture proof bag again.
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.

#### **Packaging:**

 The packaging specifications apply only to purchase orders comprising whole packaging units. If the ordered quantity exceeds or is lower than the specified packaging unit, packaging in accordance with the packaging specifications cannot be ensured.

#### Handling:

- Violation of the technical product specifications such as exceeding the nominal rated supply voltage, will void the warranty.
- Violation of the technical product specifications such as but not limited to exceeding the absolute maximum ratings will void the conformance to regulatory requirements.
- ESD prevention methods need to be followed for manual handling and processing by machinery.
- The edge castellation is designed and made for prototyping, i.e. hand soldering purposes only.
- The applicable country regulations and specific environmental regulations must be observed.
- Do not disassemble the product. Evidence of tampering will void the warranty.
- The temperature rise of the component must be taken into consideration. The operating temperature is comprised of ambient temperature and temperature rise of the component. The operating temperature of the component shall not exceed the maximum temperature specified.

These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

All topics are described in a more detailed manner in the user manual for each product.

